

Publikationen

D. Stoichescu, Leon Binder, I. Tache, P. M. Svasta, Monica I. Ciolacu (2020): Education 4.0 - Jump to Innovation IoT in Higher Education. [Status: Paper accepted]. In: Proceedings of the 2019 IEEE 25th International Symposium for Design and Technology in Electronic Packaging (SIITME) [Oct 23-26, 2019; Cluj-Napoca, Romania], New York, NY, USA.

Heribert Popp, Leon Binder, Monica I. Ciolacu (2020): Enabling IoT in Education 4.0 with Biosensors from Wearables and Artificial Intelligence. [Status: Paper accepted]. In: Proceedings of the 2019 IEEE 25th International Symposium for Design and Technology in Electronic Packaging (SIITME) [Oct 23-26, 2019; Cluj-Napoca, Romania], New York, NY, USA.

Leon Binder, Ali Fallah Tehrani, P. M. Svasta, Monica I. Ciolacu (2018): Education 4.0 - Artificial Intelligence Assisted Higher Education: Early Recognition System with Machine Learning to Support Students' Success. In: 2018 IEEE 24th International Symposium for Design and Technology in Electronic Packaging (SIITME). DOI: 10.1109/SIITME.2018.8599203.

Heribert Popp, Leon Binder, Monica I. Ciolacu, R. Beer (2018): Education 4.0 für Akademiker 4.0 Kompetenzen – Blended Learning 4.0 Prozess mit Learning Analytics Cockpit. In: Proceedings der Pre-Conference-Workshops der 16. E-Learning Fachtagung Informatik co-located with 16th e-Learning Conference of the German Computer Society (DeLFI 2018).

Heribert Popp, Leon Binder, Monica I. Ciolacu (2018): Blended Learning 4.0-Prozess: Effizient und Klunterstützt. In: Tagungsband zum 17. E-Learning Tag der FH JOANNEUM University of Applied Sciences (13.09.2018; Graz, Österreich), Graz, Österreich.

Heribert Popp, Leon Binder, Monica I. Ciolacu, R. Beer: Education 4.0 für Akademiker 4.0 Kompetenzen -Blended Learning 4.0 Prozess mit Learning Analytics Cockpit. Workshop. In: 16. E-Learning-Fachtagung Informatik (DeLFI) und die 8. Fachtagung Hochschuldidaktik der Informatik (HDI), Frankfurt am Main.

Leon Binder, Ali Fallah Tehrani, Monica I. Ciolacu, P. Mugur Svasta: Education 4.0 - Artificial Intelligence Assisted Higher Education: Early Recognition System with Machine Learning to support Students' Success. In: 2018 IEEE 24th International Symposium for Design and Technology in Electronic Packaging (SIITME), Iasi, Romania.

Heribert Popp, Leon Binder, Monica I. Ciolacu: Smarter Blended Learning 4.0 Prozess. (Vortrag im Rahmen der "Künstliche Intelligenz-APP-Bot Session"). In: 17. E-Learning-Tag der FH JOANNEUM: "Jetzt für die Zukunft", Graz, Österreich.